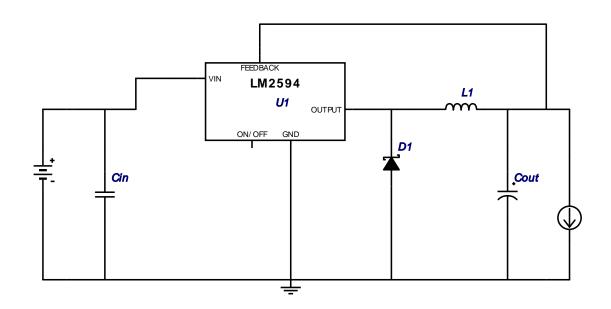


WEBENCH® Design Report

VinMin = 8.0V VinMax = 15.0VVout = 5.0Vlout = 0.5A

Device = LM2594MX-5.0 Topology = Buck Created = 12/11/11 2:30:50 PM BOM Cost = \$2.11 Total Pd = 0.67 W Footprint = 331.0 mm2 BOM Count = 5

Design: 101856/4 LM2594MX-5.0 Design 4 - LM2594MX-5.0



Electrical BOM

| # | Name | Manufacturer | Part Number | Quai | nti R yrice | Properties | Footprint |
|----|------|-------------------|-------------------------------|------|--------------------|--|-------------------|
| 1. | Cin | TDK | C3225X7R1E106M Series= X7R | 1 | \$0.18 | Cap= 10.0 µF ESR= 2.7 mOhm VDC= 25.0 V IRMS= 3.0 A | 1210 23mm2 |
| 2. | Cout | Panasonic | EEE-FK1C680P Series= FK | 1 | \$0.12 | Cap= 68.0 µF ESR= 360.0 mOhm VDC= 16.0 V IRMS= 240.0 mA | SM_RADIAL_D 84mm2 |
| 3. | D1 | ON Semiconductor | MBR0520LT1G | 1 | \$0.06 | VF@Io= 385.0 mV VRRM= 20.0 V | SOD-123 22mm2 |
| 4. | L1 | Coilcraft | MSS1048-224KLB | 1 | \$0.47 | L= 220.0 μH DCR= 500.0 mOhm | MSS1048 146mm2 |
| 5. | U1 | Texas Instruments | LM2594MX-5.0 | 1 | \$1.28 | Switcher | M08A 55mm2 |

Operating Values

| operation granted | | | | | |
|-------------------|----|-----------|-------------|----------|--------------------------------------|
| | # | Name | Value | Category | Description |
| | 1. | Cin IRMS | 241.452 m A | Current | Input capacitor RMS ripple current |
| | 2. | Cout IRMS | 29.66 m A | Current | Output capacitor RMS ripple current |
| | 3. | IC lpk | 551.372 m A | Current | Peak switch current in IC |
| | 4. | lin Avg | 211.29 m A | Current | Average input current |
| | 5. | L lpp | 102.744 m A | Current | Peak-to-peak inductor ripple current |
| | 6. | Q lavg | 185.187 m A | Current | Q lavg |
| | 7. | BOM Count | 5.0 | General | Total Design BOM count |
| | | | | | |

| # | Name | Value | Category | Description |
|-----|--------------|--------------|----------|---|
| 8. | FootPrint | 331.0 mm2 | General | Total Foot Print Area of BOM components |
| 9. | Frequency | 150.0 k Hz | General | Switching frequency |
| 10. | IC Tolerance | 0.0 V | General | IC Feedback Tolerance |
| 11. | Mode | CCM | General | Conduction Mode |
| 12. | Pout | 2.5 W | General | Total output power |
| 13. | Q Vsat Act | 845.638 m V | General | Q Vsat |
| 14. | Total BOM | \$2.11 | General | Total BOM Cost |
| 15. | Cross Freq | 10.0 k Hz | Op_point | Bode plot crossover frequency |
| 16. | Duty Cycle | 37.037 deg | Op_point | Duty cycle |
| 17. | Efficiency | 78.882 % | Op_point | Steady state efficiency |
| 18. | IC Tj | 90.018 degC | Op_point | IC junction temperature |
| 19. | ICThetaJA | 150.0 degC/W | Op_point | IC junction-to-ambient thermal resistance |
| 20. | IOUT_OP | 500.0 m Å | Op_point | lout operating point |
| 21. | Phase Marg | 57.133 deg | Op_point | Bode Plot Phase Margin |
| 22. | VIN_OP | 15.0 V | Op_point | Vin operating point |
| 23. | Vout p-p | 36.988 m V | Op_point | Peak-to-peak output ripple voltage |
| 24. | Cin Pd | 157.408 μ W | Power | Input capacitor power dissipation |
| 25. | Cout Pd | 316.687 µ W | Power | Output capacitor power dissipation |
| 26. | Diode Pd | 121.203 m W | Power | Diode power dissipation |
| 27. | IC Pd | 400.119 m W | Power | IC power dissipation |
| 28. | L Pd | 137.5 m W | Power | Inductor power dissipation |
| 29. | Total Pd | 669.303 m W | Power | Total Power Dissipation |

Design Inputs

| # | Name | Value | Description |
|----|---------|-------------|-------------------------------|
| 1. | lout | 500.0 mA | Maximum Output Current |
| 2. | lout1 | 500.0 mAmps | Output Current #1 |
| 3. | VinMax | 15.0 V | Maximum input voltage |
| 4. | VinMin | 8.0 V | Minimum input voltage |
| 5. | Vout | 5.0 V | Output Voltage |
| 6. | Vout1 | 5.0 Volt | Output Voltage #1 |
| 7. | base_pn | LM2594 | National Based Product Number |
| 8. | Та | 30.0 degC | Ambient temperature |

Design Assistance

1. LM2594 Product Folder: http://www.national.com/pf/LM/LM2594.html: contains the data sheet and other resources.

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